



United States Patent and Trademark Office

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APPLICATION NUMBER

FILING/RECEIPT DATE

FIRST NAMED APPLICANT

ATTORNEY DOCKET NUMBER

10/022,098

10/30/2001

Masaaki Kawasumi

112A 3189

KODA & ANDROLIA Suite 3850 2029 Century Park East Los Angeles, CA 90067



CONFIRMATION NO. 5240 FORMALITIES LETTER
OC000000007515596

Date Mailed: 02/21/2002

NOTICE TO FILE MISSING PARTS OF NONPROVISIONAL APPLICATION

FILED UNDER 37 CFR 1.53(b)

Filing Date Granted

An application number and filing date have been accorded to this application. The item(s) indicated below, however, are missing. Applicant is given **TWO MONTHS** from the date of this Notice within which to file all required items and pay any fees required below to avoid abandonment. Extensions of time may be obtained by filing a petition accompanied by the extension fee under the provisions of 37 CFR 1.136(a).

- The oath or declaration is missing.
 A properly signed oath or declaration in compliance with 37 CFR 1.63, identifying the application by the above Application Number and Filing Date, is required.
- To avoid abandonment, a late filing fee or oath or declaration surcharge as set forth in 37 CFR 1.16(l) of \$130 for a non-small entity, must be submitted with the missing items identified in this letter.
- The application was filed in a language other than English. Applicant is required to provide an English translation of the specification and a statement that the translation is accurate. (See 37 CFR 1.52(d)).
- The balance due by applicant is \$ 130.

Adiustment date: 05/21/2002 SSALEEKU 04/18/2002 NEGNIGHHI 06000137 111445 10022098 01-FC:105 130.00 CR

A copy of this notice <u>MUST</u> be returned with the reply.

Customer Service Center

Initial Patent Examination Division (703) 308-1202

PART 2 - COPY TO BE RETURNED WITH RESPONSE

04/18/2002 NNOHANN1 00000137 111445 10022098

01-FC:105-

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112A 3189

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:

MASAAKI KAWASUMI et al.

Serial No:

10/022,098

Filed: October 30, 2001

For:

THERMAL INSULATION BOX

Art Unit:

Examiner:

RESPONSE TO NOTICE TO FILE MISSING PARTS

Assistant Commissioner for Patents Washington, D.C. 20231

Box: Missing Parts

Dear Sir:

In response to the Notice to File Missing Parts of Nonprovisional Application dated February 21, 2002 (copy enclosed), in connection with the above-identified application, enclosed herewith are a signed Declaration & Power of Attorney and a check in the sum of \$130 as the late filing fee. Also enclosed please find an Assignment, Recordation Form Cover Sheet and check in the sum of \$40 as the recordation fee.

In addition, enclosed herein please find a verified English translation of the specification which was originally filed in Japanese. Applicant respectfully submits that the fee of \$130.00 under 37 CFR 1.17(i) was paid when the application was filed on October 30, 2001.

If there are any further fees required in connection with the acceptance of the enclosed documents, please charge those fees to KODA & ANDROLIA DEPOSIT ACCOUNT NO. 11-1445.

Respectfully submitted,

KODA & ANDROLIA

William L. Androlia Reg. No. 27,177

2029 Century Park East **Suite 3850**

Los Angeles, CA 90067-3024

Tel: Fax: (310) 277-1391 (310) 277-4118 I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to:

Assistant Commissioner for Patents, Washington D.C. 20231, on

April 10, 2002

Date of Deposit

William L Androlia

Signature

4/10/2002

Date



STATEMENT

I, Hiroshi Kondo, state:

that I am thoroughly conversant with the Japanese and English languages;

that I am presently engaged as a translator in these languages; and that the attached English translation of the Japanese language specification of Application Number 10/022,098 filed in the Patent Office on October 30, 2001 is accurate.

Date: Apul/0, 2002

Hiroshi Kondo